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SIEMENS AKTIENGESELLSCHAFT

T-23-07

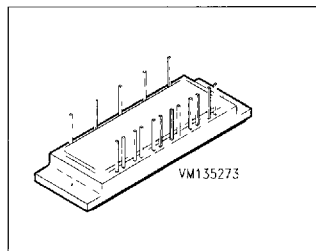
IGBT Module

Preliminary Data

BSM 10 GD 100 D

 $V_{CE} = 1000 \text{ V}$
 $I_C = 6 \times 11 \text{ A at } T_C = 25^\circ\text{C}$
 $I_C = 6 \times 10 \text{ A at } T_C = 40^\circ\text{C}$

- Power module
- 3-phase full bridge
- Including fast free-wheel diodes
- Package with insulated metal base plate
- Package outlines/Circuit diagram: 6a¹⁾



Type	Ordering Code
BSM 10 GD 100 D	C67076-A2507-A52

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V_{CE}	1000	V
Collector-gate voltage, $R_{GE} = 20 \text{ k}\Omega$	V_{CGR}	1000	
Gate-emitter voltage	V_{GE}	± 20	
Continuous collector current, $T_C = 25^\circ\text{C}$ $T_C = 40^\circ\text{C}$	I_C	11 10	A
Pulsed collector current, $T_C = 25^\circ\text{C}$ $T_C = 40^\circ\text{C}$	$I_{C \text{ puls}}$	22 20	
Storage temperature range	T_{stg}	- 40 ... + 125	$^\circ\text{C}$
Junction Temperature	T_J	150	
Power dissipation, $T_C = 40^\circ\text{C}$	P_{tot}	50	W
Thermal resistance, chip-case	R_{thJC}	≤ 2.5	K/W
DIN humidity category, DIN 40 040	—	F	—
IEC climatic category, DIN IEC 68-1	—	40/150/56	—

¹⁾ See chapter Package Outline and Circuit Diagrams.

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Electrical Characteristics

at $T_j = 25\text{ °C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Collector-emitter breakdown voltage $V_{GE} = 0$, $I_C = 0.15\text{ mA}$	$V_{(BR)CES}$	1000	—	—	V
Gate threshold voltage $V_{GE} = V_{CE}$, $I_C = 0.7\text{ mA}$	$V_{GE(th)}$	4.8	5.5	6.2	
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $T_j = 25\text{ °C}$ $T_j = 150\text{ °C}$	$V_{CE(sat)}$	— —	2.8 4.0	3.3 4.5	
Zero gate voltage collector current $V_{CE} = 1000\text{ V}$, $V_{GE} = 0$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	I_{CES}	— —	— —	500 2000	μA
Gate-emitter leakage current $V_{GE} = 20\text{ V}$, $V_{CE} = 0$	I_{GES}	—	0.1	100	nA

AC Characteristics

Forward transconductance $V_{CE} = 20\text{ V}$, $I_C = 10\text{ A}$	g_{fs}	3.5	—	—	S
Input capacitance $V_{CE} = 25\text{ V}$, $V_{GE} = 0$, $f = 1\text{ MHz}$	C_{iss}	—	1300	—	pF
Output capacitance, $V_{GS} = 0$ $V_{CE} = 25\text{ V}$, $V_{GE} = 0$, $f = 1\text{ MHz}$	C_{oss}	—	100	—	
Reverse transfer capacitance $V_{CE} = 25\text{ V}$, $V_{GE} = 0$, $f = 1\text{ MHz}$	C_{rss}	—	50	—	

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Switching Characteristics

at $T_j = 125^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Resistive Load

Turn-on delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	$t_{d(\text{on})}$	—	15	—	ns
Rise time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	t_r	—	150	—	
Turn-off delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	$t_{d(\text{off})}$	—	140	—	
Fall time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	t_f	—	200	—	

Inductive Load

Turn-on delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	$t_{d(\text{on})}$	10 —	15 —	20 —	ns
Rise time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	t_r	5 —	10 —	15 —	
Turn-off delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	$t_{d(\text{off})}$	100 —	140 —	170 —	
Fall time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	t_f	10 —	18 —	25 —	
Turn-off loss ($E_{\text{off}1} + E_{\text{off}2}$) $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{g(\text{on})} = 3.3\ \Omega$, $R_{g(\text{off})} = 3.3\ \Omega$	$E_{\text{off}1}$ $E_{\text{off}2}$	— —	0.5 0.6	— —	mWs

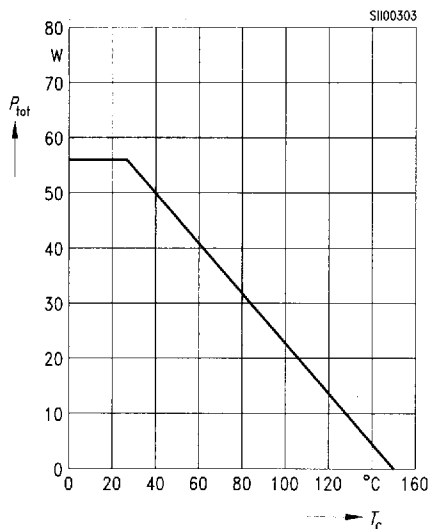
Electrical Characteristicsat $T_J = 25\text{ °C}$, unless otherwise specified.

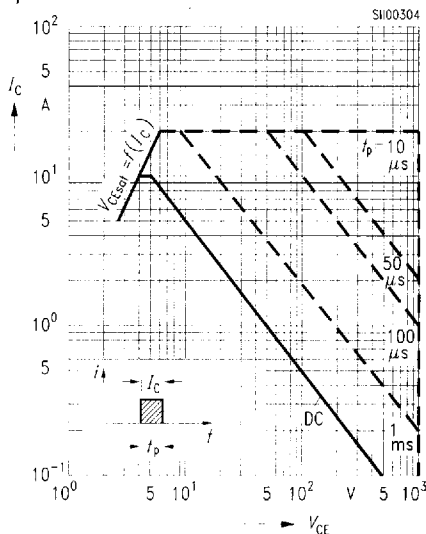
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

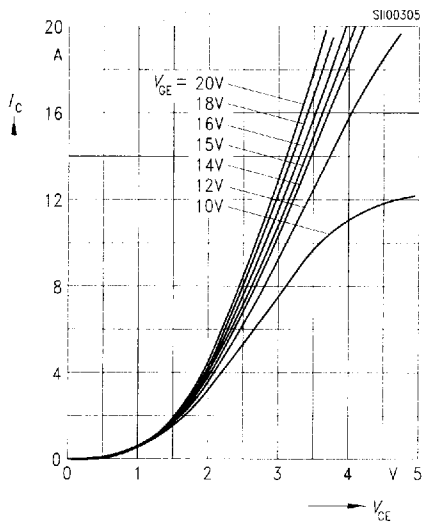
Free-Wheel Diode

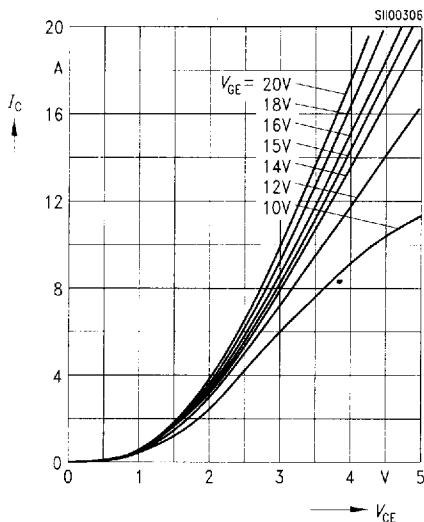
Diode forward voltage $I_F = 10\text{ A}$, $V_{GE} = 0$ $T_J = 25\text{ °C}$ $T_J = 125\text{ °C}$	V_F	— —	1.8 1.6	— —	V
Reverse recovery time $I_F = 10\text{ A}$, $V_R = 600\text{ V}$ $V_{GE} = 0$, $di_F/dt = -500\text{ A/}\mu\text{s}$ $T_J = 125\text{ °C}$	t_{rr}	—	0.08	—	μs
Reverse recovery charge $I_F = 10\text{ A}$, $V_R = 600\text{ V}$ $V_{GE} = 0$, $di_F/dt = -500\text{ A/}\mu\text{s}$ $T_J = 25\text{ °C}$ $T_J = 125\text{ °C}$	Q_{rr}	— —	0.8 2.5	— —	μC
Soft factor $I_F = 10\text{ A}$, $V_R = 600\text{ V}$ $V_{GE} = 0$, $di_F/dt = -500\text{ A/}\mu\text{s}$ $T_J = 125\text{ °C}$	S	—	1	—	—
Thermal resistance Chip-case	R_{thJC}	—	—	4.5	K/W

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Characteristics at $T_j = 25^\circ\text{C}$, unless otherwise specified.
Power dissipation $P_{\text{tot}} = f(T_C)$

parameter: $T_j = 150^\circ\text{C}$

Safe operating area $I_C = f(V_{CE})$

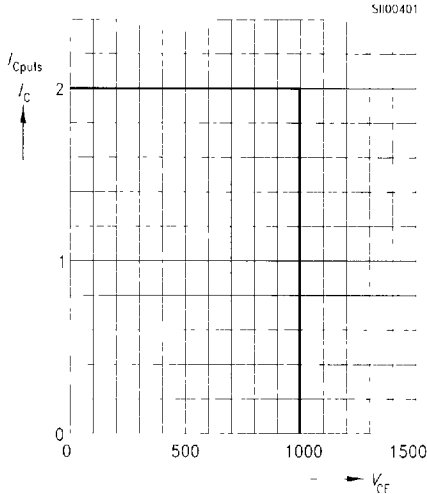
parameter: single pulse, $T_C = 25^\circ\text{C}$
 $T_j \leq 150^\circ\text{C}$

Typ. output characteristics $I_C = f(V_{CE})$

parameter: $t_p = 80 \mu\text{s}$, $T_j \leq 25^\circ\text{C}$

Typ. output characteristics $I_C = f(V_{CE})$

parameter: $t_p = 80 \mu\text{s}$, $T_j \leq 125^\circ\text{C}$


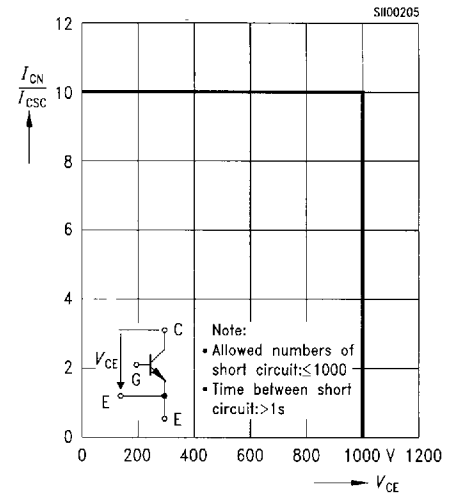
Reverse biased safe operating area

$I_C = f(V_{CE})$, parameter: $T_J = 125^\circ\text{C}$,
 $V_{GE} = 15\text{ V}$, $R_{g(\text{off})} = 3.3\ \Omega$,
 L (parasitic inductance, module) $< 50\text{ nH}$



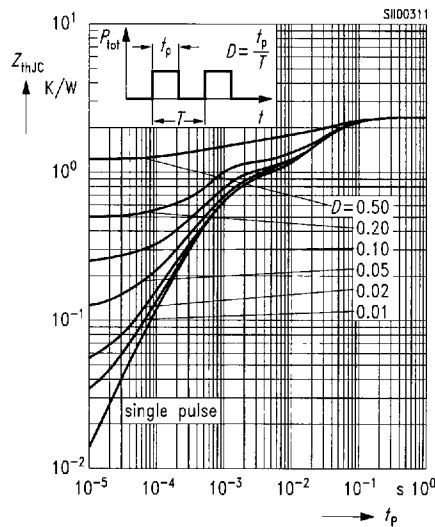
Safe operating area,

short circuit $I_C = f(V_{CE})$, $V_{GE} = \pm 15\text{ V}$
 $T_J \leq 150^\circ\text{C}$, $t_{SC} \leq 10\ \mu\text{s}$, $L < 50\text{ nH}$



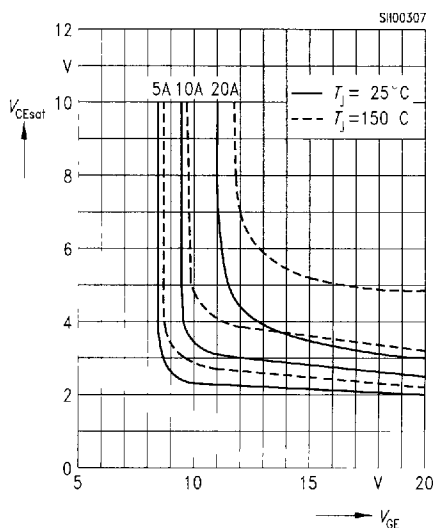
Transient thermal impedance

$Z_{thJC} = f(t_p)$, parameter: $D = t_p / T$

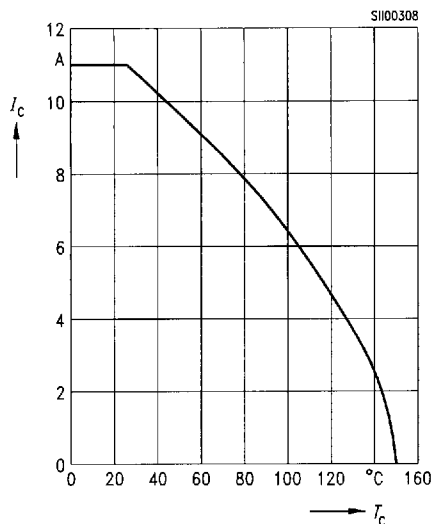


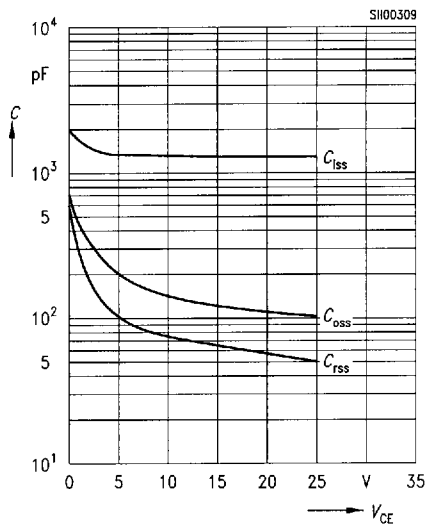
Typ. on-state characteristics

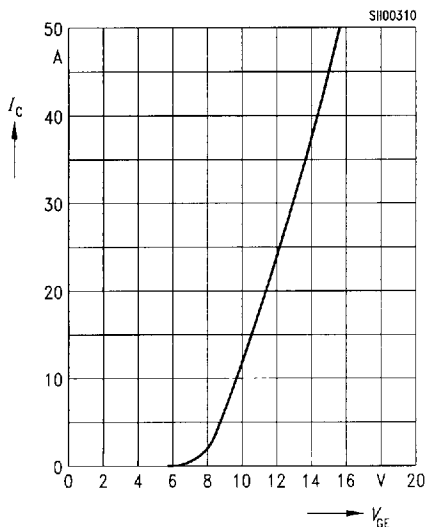
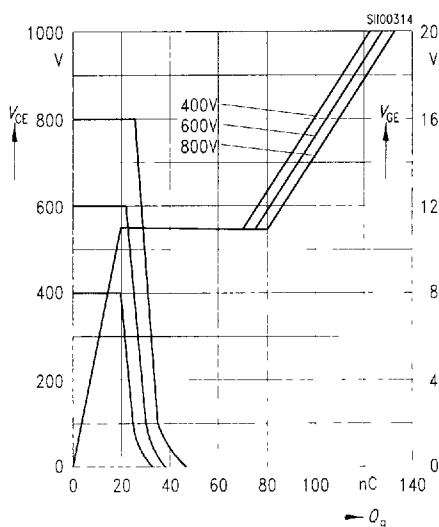
$V_{CE(\text{sat})} = f(V_{GE})$, parameter: I_C , T_J



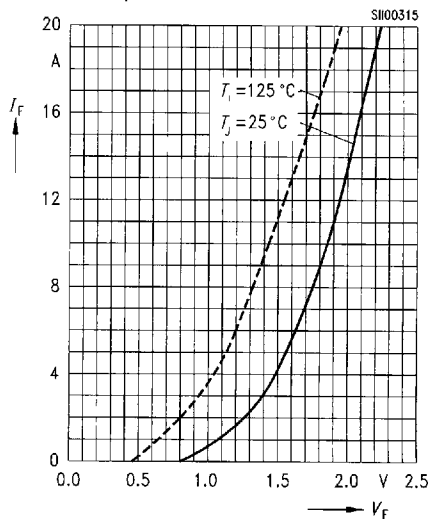
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Collector current $I_C = f(T_C)$

parameter: $V_{GE} \geq 15 \text{ V}$, $T_I = 150^\circ\text{C}$

Typ. capacitances $C = f(V_{CE})$

parameter: $V_{GE} = 0$, $f = 1 \text{ MHz}$

Typ. transfer characteristics $I_C = f(V_{GE})$

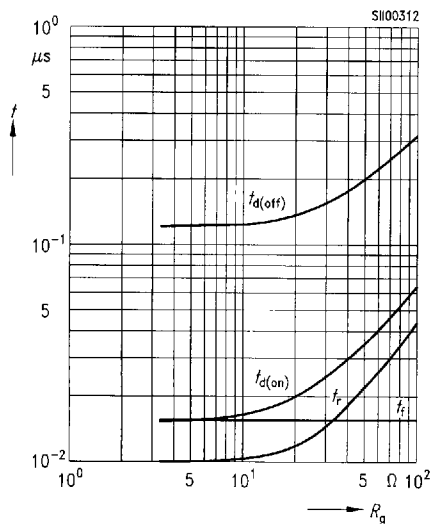
parameter: $t_p = 80 \mu\text{s}$, $V_{CE} = 20 \text{ V}$

Typ. gate charge V_{CE} , $V_{GE} = f(Q_g)$


**Forward characteristics of
fast recovery reverse diode** $I_F = f(V_F)$
parameter: T_j



Typ. switching time $t = f(R_G)$

Inductive load, parameter: $T_j = 125^\circ\text{C}$
 $V_{CE} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $I_C = 10\text{ A}$



Typ. switching time $t = f(I_C)$

Inductive load, parameter: $T_j = 125^\circ\text{C}$
 $V_{CE} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_G = 3.3\text{ }\Omega$

